

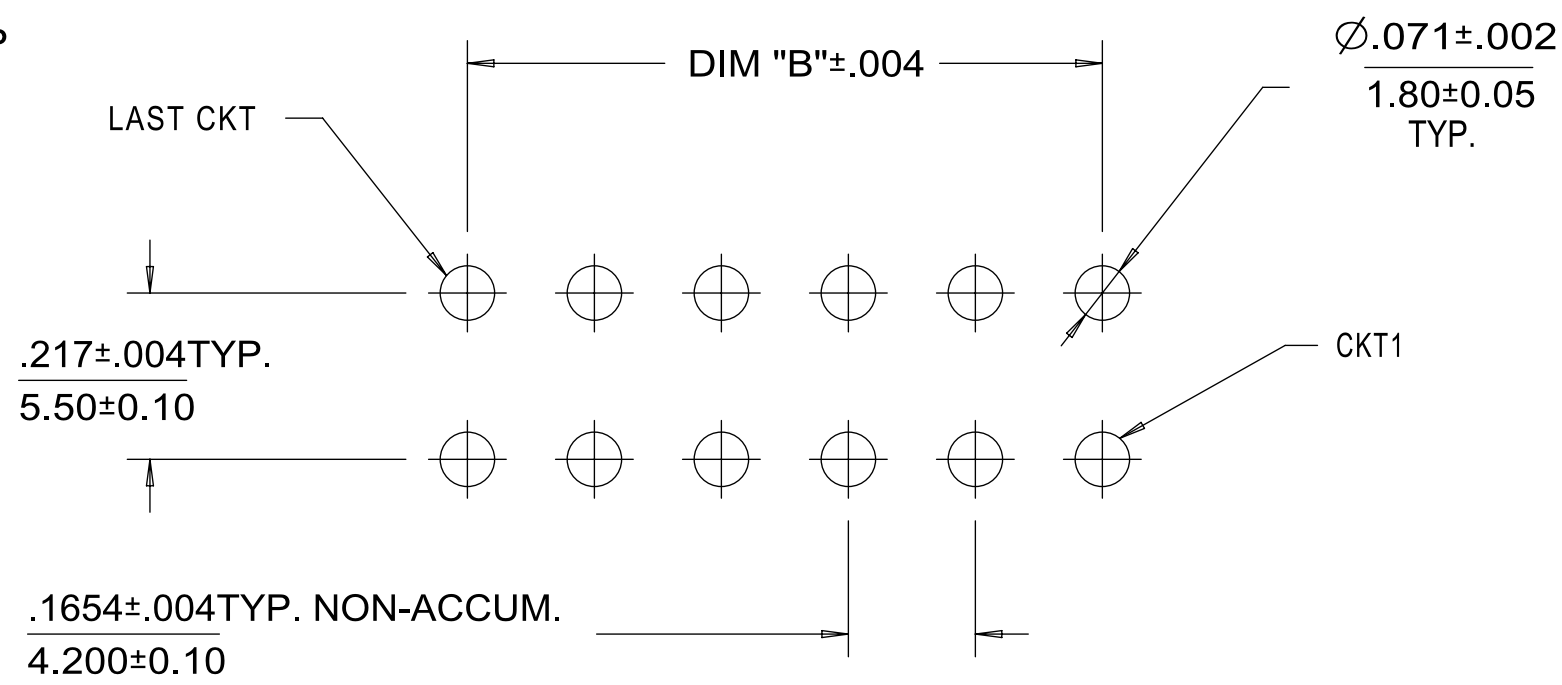
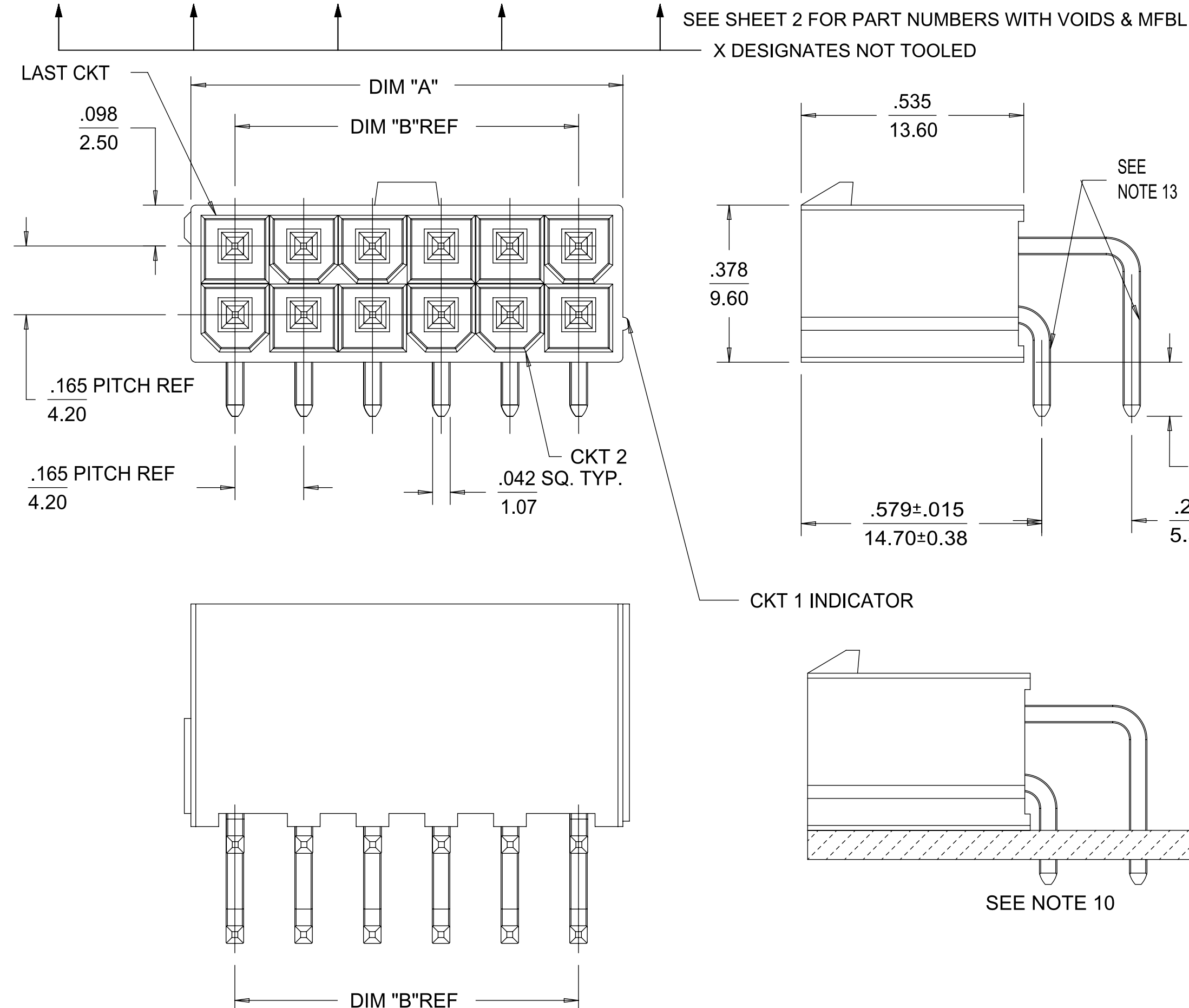
COLOR = BLACK

COLOR = NATURAL

NOTES:

- MATERIAL:
HOUSING - LIQUID CRYSTAL POLYMER (LCP), COLOR: SEE CHART.
TERMINAL - BRASS
- TERMINAL PLATING: TIN = .000100/0.00254 MATTE TIN OVER
.000050/0.00127 NICKEL OVERALL
GOLD= .000030/0.00076 MIN. SELECT GOLD OVER
.000100/0.00254 MIN. SELECT MATTE TIN OVER
.000050/0.00127 MIN NICKEL OVERALL
- PRODUCT SPECIFICATION: PS-5556-001 OR PS-45750-001.
- PACKAGING SPECIFICATION: TRAY PACKED PER PK-5569-003 OR
TAPE AND REEL PACKAGED PER PK-46991-001.
- PART MATES WITH MINIFIT JR RECEPTACLE SERIES 5557
- DISCOLORIZATION IN THE BANDOLIER CARRIER AREA OF THE PIN IS
INHERENT TO THE PLATING PROCESS AND IS DUE TO THE MASKING EFFECT
OF THE CARRIER. THIS DISCOLORIZATION IS A NON-FUNCTIONAL AREA OF
THE PIN AND WILL NOT AFFECT THE PERFORMANCE OF THE HEADER ASSEMBLY.
- CONNECTORS ARE NOT TO BE MATED OR UNMATED WHILE CIRCUITS ARE LIVE.
- PARTS ARE NOT DESIGNED FOR CURRENT SHARING.
- PART IS INTENDED FOR PIN IN PASTE REFLOW SOLDER ONLY.
- TO AVOID INTERFERENCE BETWEEN THE RECEPTACLE AND PCB. HEADER MUST
BE PLACED AT THE EDGE OF PCB AS SHOWN.
- PIN RETENTION IN HOUSING IS 2.2 LBS/1 KG MIN. BOTH
DIRECTIONS FOR TIN PLATING.
PIN RETENTION IN HOUSING IS 1.0 LBS/0.45 KG MIN. BOTH
DIRECTIONS FOR GOLD PLATING.
- THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.
- FORMING MARKS ON PINS ARE ACCEPTABLE.
- CIRCUITS SHOWN PROVIDE THE MATE-FIRST/BREAK-LAST FEATURE.
SEE CHART ON SHEET 2 FOR SPECIFIC CIRCUIT LOCATIONS.
- TEXT ON PART IS FOR REFERENCE ONLY. TEXT AND TEXT LOCATION MAY VARY DEPENDING ON
PART NUMBER AND/OR TOOL.

H	CKT SIZE	TIN PLATING		GOLD PLATING		TIN PLATING		DIM "A"	DIM "B"
		TRAY PACK MATERIAL NUMBER	TAPE & REEL MATERIAL NUMBER	TRAY PACK MATERIAL NUMBER	TAPE & REEL MATERIAL NUMBER	TRAY PACK MATERIAL NUMBER			
4		46991-1004	46991-4004 X	46991-2004	46991-3004			.38/9.6	.165/4.20
6		46991-1006 X	46991-4006 X	46991-2006 X	46991-3006			.54/13.8	.331/8.40
8		46991-1008	46991-4008	46991-2008	46991-3008			.71/18.0	.496/12.60
10		46991-1010	46991-4010 X	46991-2010 X	46991-3010	X	46991-1110	.87/22.2	.661/16.80
12		46991-1012 X	46991-4012	46991-2012 X	46991-3012			1.04/26.4	.827/21.00
14	X	46991-1014 X	46991-4014 X	46991-2014 X	46991-3014			1.21/30.6	.992/25.20
16	X	46991-1016 X	46991-4016 X	46991-2016 X	46991-3016			1.37/34.8	1.160/29.40
18	X	46991-1018 X	46991-4018 X	46991-2018 X	46991-3018			1.54/39.0	1.323/33.60
20	X	46991-1020 X	46991-4020 X	46991-2020 X	46991-3020			1.70/43.2	1.488/37.80
22	X	46991-1022 X	46991-4022 X	46991-2022 X	46991-3022			1.87/47.4	1.654/42.00
24		46991-1024	46991-4024 X	46991-2024 X	46991-3024			2.03/51.6	1.819/46.20



RECOMMENDED PCB HOLE LAYOUT FOR .070/1.78 MAX THICK P.C. BOARD
VIEWED FROM COMPONENT SIDE

SYMBOLS	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
	DIMENSION UNITS	SCALE	CURRENT REV/DESC: ADD 46991-5003	
∇ = 0	IN/MM	4:1	EC NO: 641577	
∇ = 0	GENERAL TOLERANCES (UNLESS SPECIFIED)			
∇ = 0		MM	INCH	DRWN: LSCHWALLER 2020/07/15
S = 0	4 PLACES	±	±	CHK'D: DSTEIER 2020/07/22
∇ = 0	3 PLACES	±	± 0.15	APPR: FSMITH 2020/08/07
∇ = 0	2 PLACES	± 0.25	± 0.1	INITIAL REVISION:
∇ = 0	1 PLACE	± 0.38	±	DRWN: JKLOSTERMEIE 2008/12/19
∇ = 0	0 PLACES	±	±	APPR: FSMITH 2008/12/15
∇ = 0	ANGULAR TOL	± 0.5°		THIRD ANGLE PROJECTION
∇ = 0	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			DRAWING SERIES
				C-SIZE 46991
DOCUMENT STATUS	P1	RELEASE DATE	2020/08/07 19:11:52	DOCUMENT NUMBER
				SD-46991-001
				DOC TYPE DOC PART REVISION
				PSD 000 C11
				MATERIAL NUMBER CUSTOMER SHEET NUMBER
				SEE CHART GENERAL MARKET 1 OF 2

